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May 2008

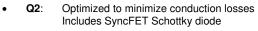
FDS6984AS

FAIRCHILD

Dual Notebook Power Supply N-Channel PowerTrench[®] SyncFET[™] General Description Features

The FDS6984AS is designed to replace two single SO-8 MOSFETs and Schottky diode in synchronous DC:DC power supplies that provide various peripheral voltages for notebook computers and other battery powered electronic devices. FDS6984AS contains two unique 30V, N-channel, logic level, PowerTrench MOSFETs designed to maximize power conversion efficiency.

The high-side switch (Q1) is designed with specific emphasis on reducing switching losses while the low-side switch (Q2) is optimized to reduce conduction losses. Q2 also includes a patented combination of a MOSFET monolithically integrated with a Schottky diode.



8.5A, 30V $R_{DS(on)}$ max= 20 m Ω @ V_{GS} = 10V

 $R_{DS(on)}$ max= 28 m Ω @ V_{GS} = 4.5V

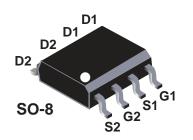
• Q1: Optimized for low switching losses Low gate charge (8nC typical)

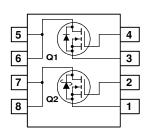
5.5A, 30V $R_{DS(on)}$ max= 31 m Ω @ V_{GS} = 10V

 $R_{DS(on)}$ max= 40 m Ω @ V_{GS} = 4.5V

RoHS Compliant







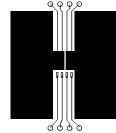
Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter			Q2	Q1	Units
V _{DSS}	Drain-Source Voltage			30	30	V
V _{GSS}	Gate-Source Voltage			±20	±20	V
ID	Drain Curre	ent - Continuous	(Note 1a)	8.5	5.5	А
		- Pulsed		30	20	
PD	Power Dissipation for Dual Operation			2		W
	Power Dissipation for Single Operation (Note 1a)			1.6		
			(Note 1b)		1	
			(Note 1c)	0	.9	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150		°C
Therma	I Charac	teristics				
R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1a)		nt (Note 1a)	78		°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)			40		°C/W
Packag	e Markin	g and Ordering In	formation			
Device Marking		Device	Reel Size	Tape wi	dth	Quantity
FDS6984AS		FDS6984AS	13"	12mm	n	2500 units

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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Cha	racteristics						
BV _{DSS}	Drain-Source Breakdown Voltage		Q2 Q1	30 30			V
	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	Q2 Q1			500 1	μA
		$V_{\text{DS}} = 24 \ V, \ V_{\text{GS}} = 0 \ V, \ \ T_{\text{J}} = 125^{\circ} C$	Q2		2.3		mA
			Q1		79		nA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	All			±100	nA
On Cha	racteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$ $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	Q2 Q1	1 1	1.7 1.8	3 3	V
$\Delta V_{GS(th)}$ ΔT_{J}	Gate Threshold Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to 25°C $I_D = 250$ uA, Referenced to 25°C	Q2 Q1		-3 -4		mV/°C
R _{DS(on)} S	Static Drain-Source On-Resistance		Q2		17 24 21	20 32 28	mΩ
		$ \begin{array}{l} V_{\rm GS} = 10 \; V, \; I_{\rm D} = 5.5 \; A \\ V_{\rm GS} = 10 \; V, \; I_{\rm D} = 5.5 \; A, \; T_{\rm J} = 125^{\circ}C \\ V_{\rm GS} = 4.5 \; V, \; I_{\rm D} = 4.6 \; A \end{array} $	Q1		26 34 32	31 43 40	
I _{D(on)}	On-State Drain Current	V_{GS} = 10 V, V_{DS} = 5 V	Q2 Q1	30 20			A
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_D = 8.5 A$ $V_{DS} = 5 V, I_D = 5.5 A$	Q2 Q1		25 18		S
Dynami	c Characteristics						
C _{iss}	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz	Q2 Q1		530 420		pF
C _{oss}	Output Capacitance		Q2 Q1		170 120		pF
C _{rss}	Reverse Transfer Capacitance		Q2 Q1		60 50		pF
R _G	Gate Resistance	V _{GS} = 15mV, f = 1.0 MHz	Q2 Q1		3.1 2.2		Ω

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Switchi	ng Characteristics (Note 2	?)					
t _{d(on)}	Turn-On Delay Time		Q2		8	16	ns
tr	Turn-On Rise Time	-	Q1 Q2		9 5	18 10	ns
ι,		$V_{DD} = 15 V, I_D = 1 A,$	Q1		6	12	110
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 6 \Omega$	Q2		23	37	ns
t _f	Turn-Off Fall Time		Q1 Q2		22 4	35 8	ns
lf			Q2 Q1		2	4	115
t _{d(on)}	Turn-On Delay Time		Q2		9	18	ns
	Turn-On Rise Time	-	Q1 Q2		10 7	19 14	
tr	Turn-On Rise Time	$V_{DD} = 15 V, I_D = 1 A,$	Q2 Q1		11	20	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 4.5V. R _{GEN} = 6 Ω	Q2		13	24	ns
		$V_{GS} = 7.3V$, $T_{GEN} = 0.32$	Q1		13	24	
t _f	Turn-Off Fall Time		Q2 Q1		4 3	8 6	ns
Q _{g(TOT)}	Total Gate Charge, Vgs = 10V		Q2		10	14	nC
		Q2:	Q1		8	11	
Q _g	Total Gate Charge, Vgs = 5V	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$	Q2 Q1		5 4	8 6	nC
Q _{as}	Gate-Source Charge	01:	Q2		1.5	0	nC
5-		$V_{DS} = 15 \text{ V}. \text{ I}_{D} = 5.5 \text{ A}$	Q1		1.3		
Q _{gd}	Gate-Drain Charge		Q2 Q1		1.9 1.5		nC
Ducin () Nauraa Diada Charaatari	ation and Maximum Datin			1.5		
Drain-s	-Source Diode Characteristics and Maximum Rating		gs Q2	i	i	3.0	A
18			Q1			1.3	~
t _{rr}	Reverse Recovery Time	$I_{F} = 10A,$	Q2		13		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 300 \text{ A}/\mu \text{s}$ (Note 3)			6		nC
t _{rr}	Reverse Recovery Time	I _F = 5.5A,	Q1		17		ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100 \text{ A}/\mu \text{s}$ (Note 3)			6		nC
V _{SD}	Drain-Source Diode Forward	$V_{GS} = 0 \ V, \ I_S = 2.3 \ A$ (Note 2)	Q2		0.6	0.7	V
	Voltage	$V_{GS} = 0 V, I_S = 1.3 A$ (Note 2)	Q1		0.8	1.2	



78°C/W when mounted on a 0.5in² pad of 2 oz copper

a)



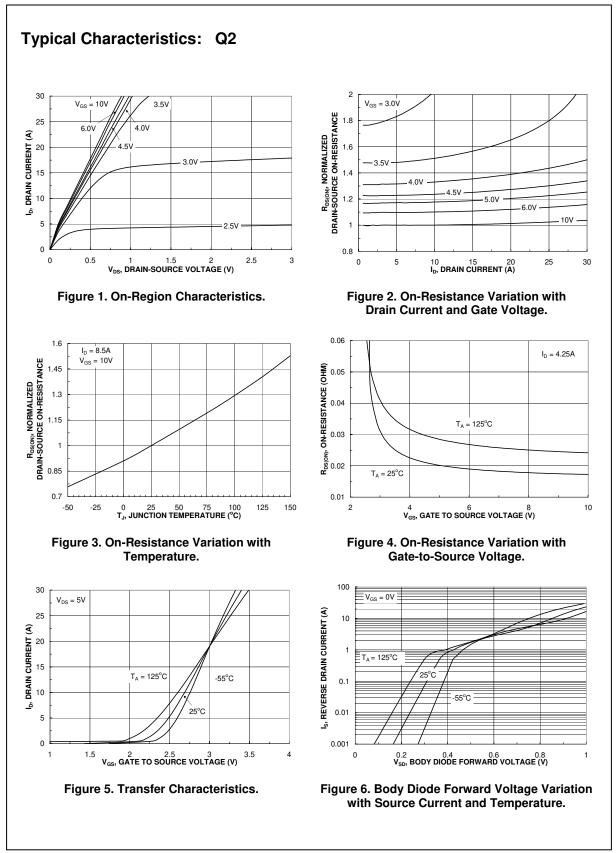
b) 125°C/W when mounted on a 0.02 in² pad of 2 oz copper

135°C/W when mounted on a minimum pad.

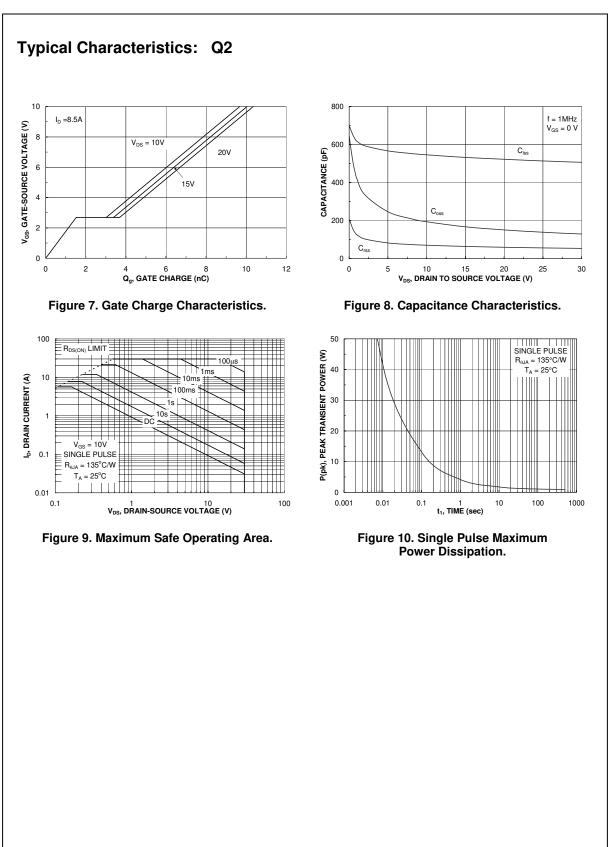
c)

Scale 1 : 1 on letter size paper

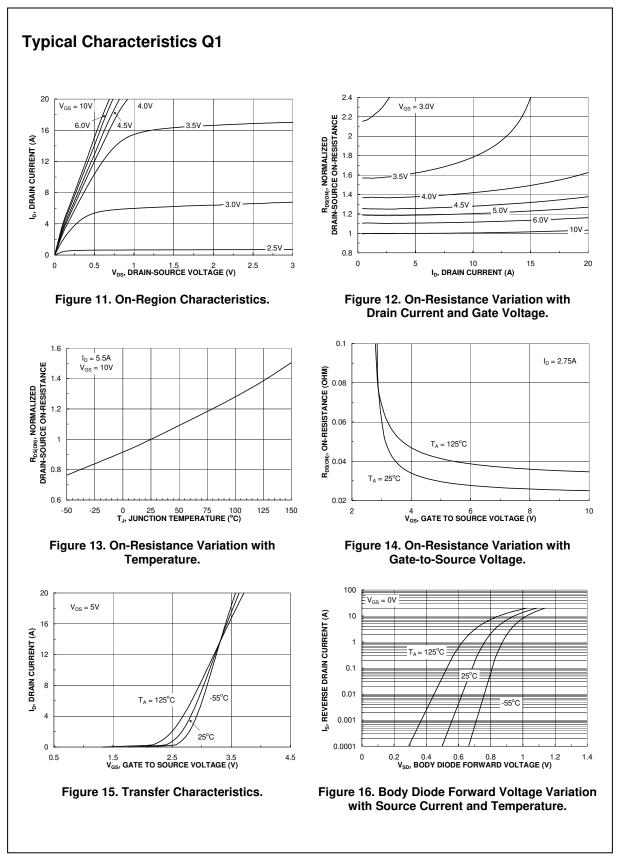
See "SyncFET Schottky body diode characteristics" below.
Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%



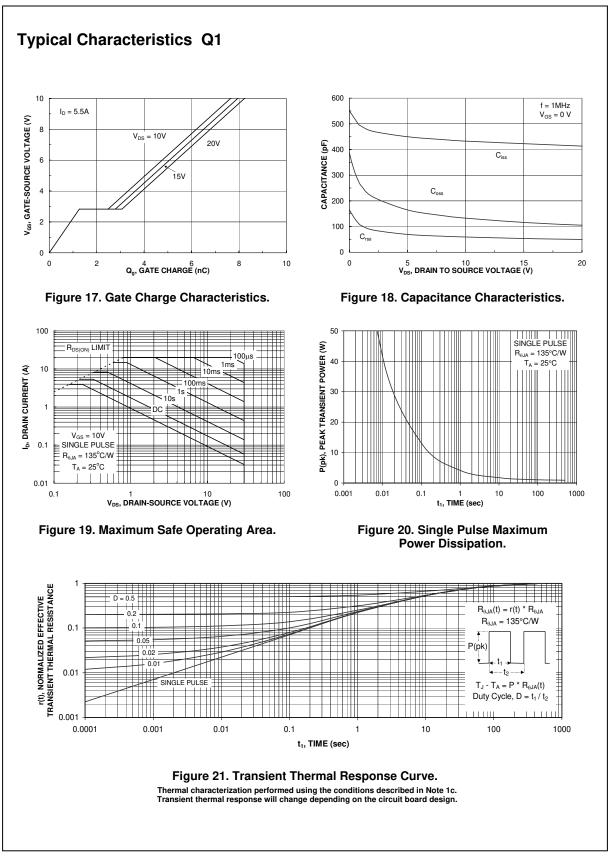
FDS6984AS Rev A1 (X)



FDS6984AS



FDS6984AS Rev A1 (X)



Typical Characteristics (continued)

SyncFET Schottky Body Diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 22 shows the reverse recovery characteristic of the FDS6984AS.

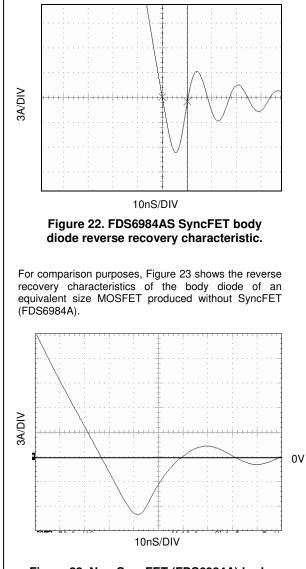


Figure 23. Non-SyncFET (FDS6984A) body diode reverse recovery characteristic.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

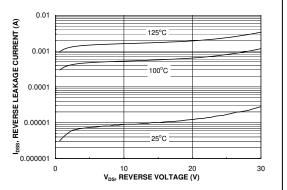


Figure 24. SyncFET body diode reverse leakage versus drain-source voltage and temperature.



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